

**Thick Film Chip Resistor - Surge
Type SCR Series**

Δ Features

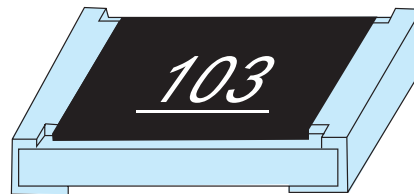
- Suitable for withstanding circuit for surge voltage
- Suitable for lead free soldering.
- Compatible with flow and reflow soldering.

Δ Applications

- Measurement Instrument
- Power Supply
- Automotive Industry
- Medical Equipment
- Telecom Equipment
- Consumer Electronics

Δ Rating

Type	Size	Power Rating at 70 °C	Max. RCWV	Max. Overload Voltage	Resistance Tolerance (%)	Temperature Coefficient (TCR; ppm/ °C)	Resistance Range		Standard Resistance Values
							Min.	Max.	
	0603	1/10W	50V	100V					
	0805	1/8W	150V	300V	± 5%(J)				
	1206	1/4W	200V	400V	± 10%(K)				
	2010	1/2W	200V	400V	±1 5%(L)	± 100	10 Ω	1M Ω	E-24
	2512	1W	200V	400V	± 20%(M)				



Δ How to Order

Part Number

example	SCR	0603	T	J	123	LF
	Type	Size	Packing	Tolerance	Resistance Value	
	SCR	0603	T: Tape	J: ±5%	123 = 12x10 ³	LF = Lead Free
		0805		K: ±10%	= 12k Ω	
		1206		L: ±15%		
		2010		M: ±20%		
		2512				

Δ Resistance Marking

E-24 Series



3 digit marking for E24

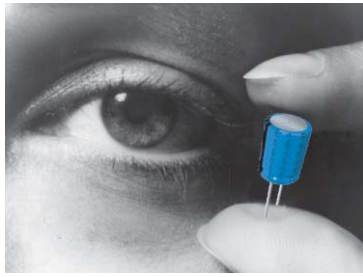
- ex. 473: 47x10³ = 47KΩ
- 105: 10x10⁵ = 1MΩ
- 1R5: 15x10⁻¹ = 1.5Ω
- 0: 0Ω



4 digit marking for E241: Ω~10mΩ

- ex. 1R00: 1Ω
- R470 470mΩ
- R010 10mΩ

Surface Mount Resistors



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△ Specifications and Test Methods

ITEM	SPECIFICATION	TEST METHOD
DC Resistance	J ± 5% K : ± 10% L : ± 1 5% M : ± 20%	IEC 60115-1 4.5 / JIS C 5202 5.1 Measure the resistance value.
Short time Overload	Δ R ≤ ± (2% + 0.1 Ω)	IEC 60115-1 4.13 / JIS C 5202 5.5 2.5X Rated voltage or Max. Overload Voltage for 5 sec. measure resistance after 30 minutes
High Voltage Pulses	Δ R ≤ ± (1% + 0.1 Ω)	IEC 801-5 1.2/50μ s 2kV 100 Pulses (Sequence 25 P / min)
Solderability	Over 95% of termination must be covered with solder	IEC 60115-1 4.17 / JIS C 5202 6.5 After immersing flux, dip in the 245 ± 2 °C molten solder bath for 3 ± 0.5 sec.
Resistance to Solder Heat	Δ R ≤ ± (1% + 0.1 Ω) No mechanical damage	IEC 60115-1 4.18 / JIS C 5202 6.4 With 260 ± 5 °C for 10 ± 1 sec.
Temperature Coefficient of Resistance (TCR)	± 100 ppm/ °C	IEC 60115-1 4.8.4.2 / JIS C 5202 5.2 Test temperature : 25 °C(T1) → -55 °C(T2) 25 °C(T1) → 125 °C(T2) $TCR (ppm/°C) = \frac{R2-R1}{R1} \times \frac{1}{T2-T1} \times 10^6$ T1: 25 °C T2: Test temperature R1: Resistance at reference temperature (T1) R2: Resistance at test temperature (T2)
Load Life Humidity	Δ R ≤ ± (3% + 0.1 Ω)	IEC 60115-1 4.24.2 / JIS C 5202 7.9 Maintain the temperature of the resistor at 40 ± 2 °C and 90~95% R.H. with the rated voltage applied. Cycle ON for 1.5 hours and OFF for 0.5 hour for 1000+48/-0 hours. After 1~4 hour, measure the resistance value.
Load Life	Δ R ≤ ± (3% + 0.1 Ω)	IEC 60115-1 4.25.1 / JIS C 5202 7.10 Permanent resistance change after 1000+48/-0 hours (1.5 hours ON, 0.5 hour OFF) at RCWV or Max. Keep the resistor at 70 ± 2 °C ambient
Intermittent Overload	Δ R ≤ ± (5% + 0.1 Ω) No mechanical damage	JIS C 5202 5.8 4.0 x Rated voltage (Max. Overload Voltage) 1 sec ON, 25 sec OFF, test 10,000 cycles
Temperature Cycle	Δ R ≤ ± (1% + 0.1 Ω) No mechanical damage	IEC 60115-1 4.19 / JIS C 5202 7.4 Repeat 5 cycles as follows -55 °C(30 min.) ~ +25 °C(2~3 min.) +125 °C(30 min.) ~ +25 °C(2~3 min.)
Insulation Resistance	Between termination and coating must be over 1000M Ω	IEC 60115-1 4.6.1.1 / JIS C 5202 5.6 Test voltage: 100 ± 15V
Bending Strength	Δ R ≤ ± (1% + 0.1 Ω) No mechanical damage	IEC 60115-1 4.33 Resistance change after bended on the 90mm PCB. Bend: 3mm for 0603, 0805 2mm for 1206, 2010, 2512

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